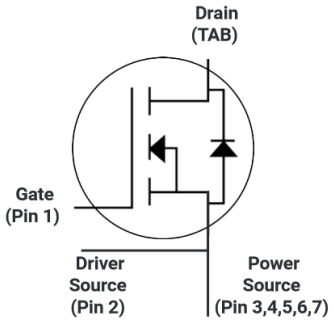
Silicon Carbide Power MOSFET （N-Channel Enhancement）

V_{DS}	1200V
$I_{D\ (25°C)}$	11A
$R_{DS(on)}$	290mΩ



Features

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free, RoHS compliant

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical Data

- **Package**: TO-263-7L
- **Terminals**: Tin plated leads
- **Polarity**: As marked

■Maximum Ratings (T_C=25℃ Unless otherwise specified）

PARAMTETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code			D2120320B7YG3		
Drain source voltage @ T_j=25°C	$V_{DS,max}$	V	1200	V_{GS}=0V, I_D=100uA	
Gate source voltage @ T_j=25°C	$V_{GS,max}$	V	-8/+22	Absolute maximum values (AC f >1Hz, duty cycle < 1%)	
Gate source voltage @ T_j=25°C	$V_{GS,op}$	V	-5/+18	Recommended operational values	
Continuous drain current @ T_c=25°C	I_D	A	11	V_{GS}=18V, Tc=25℃	Fig.17
Continuous drain current @ T_c=100°C			7.7	V_{GS}=18V, Tc=100℃	
Pulsed drain current	$I_{D(pulsed)}$	A	17	Pulse width t_p limited by $T_{j,max}$	Fig.22
Avalanche energy,Single pulse	E_{AS}	mJ	90	V_{DD}=75V, L=10mH	
Power Dissipation	P_{TOT}	W	71	T_c=25°C , Tj = 175℃	Fig.16
Power Dissipation			35.5	T_c=100°C, Tj = 175℃	
Operating junction and Storage temperature range	Tj ,Tstg	°C	-55 to +175		
Soldering temperature	T_L	°C	260	1.6mm (0.063'') from case for 10s	
Mounting torque	T_M	Nm	0.6	M3 screw Maximum of mounting process: 3	

■Static Electrical Characteristics（Tc=25℃ unless otherwise specified ）

PARAMTETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	$V_{GS(th)}$	V	2.0	3.0	4.0	V_{DS}=V_{GS}, I_D= 1.2mA	Fig.4, 11
				2.2		V_{DS}=V_{GS}, I_D= 1.2mA, Tj=175℃	
Drain source breakdown voltage	$V_{(BR)DSS}$	V	1200			V_{GS}=0V, I_D=100uA	
Drain source leakage current	I_{DSS}	uA		10	100	V_{DS}=1200V, V_{GS}= 0V	
Gate source leakage current	I_{GSS}	nA		10	100	V_{GS}= 18V, V_{DS}=0V	
Current drain source on-state resistance	$R_{DS\ ON}$	mΩ		375		V_{GS}=15V, I_D=3.5A	Fig.5, 6, 7
				290	377	V_{GS}=18V, I_D=3.5A	
				495		V_{GS}=15V, I_D=3.5A,Tj=175℃	
				460		V_{GS}=18V, I_D=3.5A,Tj=175℃	
Transconductance	g_f	S		2.4		V_{DS}=20V,I_D=3.5A	Fig.4
				2.3		V_{DS}=20V,I_D=3.5A,Tj=175℃	

■Dynamic Electrical Characteristics（Tc=25℃ unless otherwise specified ）

PARAMTETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	Ciss	pF		470		V_{DS}=1000V, V_{GS}=0V, Tj=25℃, f=1MHz, V_{AC} = 25mV	Fig.13, 14
Output capacitance	Coss			25.6			
Reverse capacitance	Crss			1.9			
Coss stored energy	Eoss	uJ		27.4			Fig.15
Gate source charge	Qgs	nC		3.8		V_{DS}=1000V, V_{GS}=-5/+18V, I_D=3.5A	Fig.12
Gate drain charge	Qgd			14			
Gate charge	Qg			19.8			
Internal gate resistance	Rg	Ω		4		f=1MHz	

■Switching Characteristics（Tc=25℃ unless otherwise specified ）

PARAMTETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on delay time	$t_{d(on)}$	ns		14.1		V_{DD}=1000V, V_{GS}=-5/+18V, I_D=3.5A, Rg=2.4Ω, L=300uH	Fig.21
Rise time	t_r			17			
Turn off delay time	$t_{d(off)}$	ns		11.8			
Fall time	t_f			36.1			

Turn on switching energy	E_{on}	uJ		91.4		V_{DD}=1000V, V_{GS}=-5/+18V, I_D=3.5A, Rg=2.4Ω, L=300uH	Fig.19, 20
Turn off switching energy	E_{off}			25.8			

■Body diode characteristics（Tc=25℃ unless otherwise specified ）

PARAMTETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	V_{SD}	V		5.1		V_{GS}=-5V,I_{SD}=1.8A	Fig.8
				3.6		V_{GS}=0V, I_{SD}=1.8A, Tj=175℃	Fig.9
Continuous diode forward current	I_S	A		10.2		V_{GS}=-5V,Tc=25℃	
Reverse recovery time	trr	nS		56.3		V_R=1000V, V_{GS}=-5V, I_D=3.5A, di/dt=1000A/uS	
Reverse recovery charge	Qrr	nC		87			
Peak reverse recovery current	Irrm	A		2.5			

■Thermal Characteristics （T_a=25℃ Unless otherwise specified）

PARAMETER	SYMBOL	UNIT	Typ.
Thermal resistance	$R_{\theta J-C}$	°C /W	2.11

■Typical Characteristics

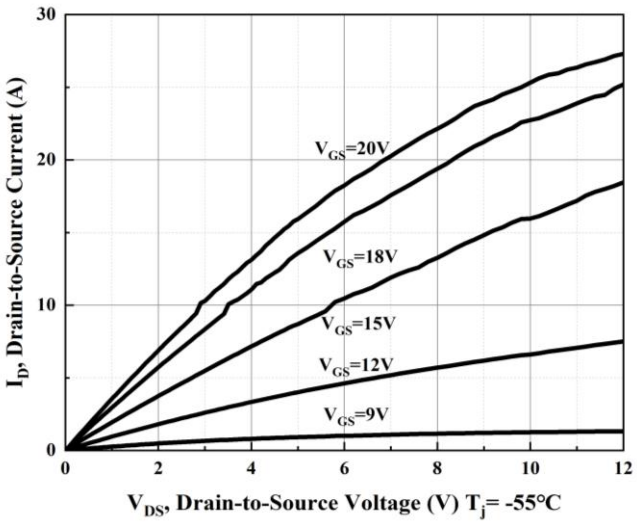


Figure 1. Output Characteristics Tj = -55℃

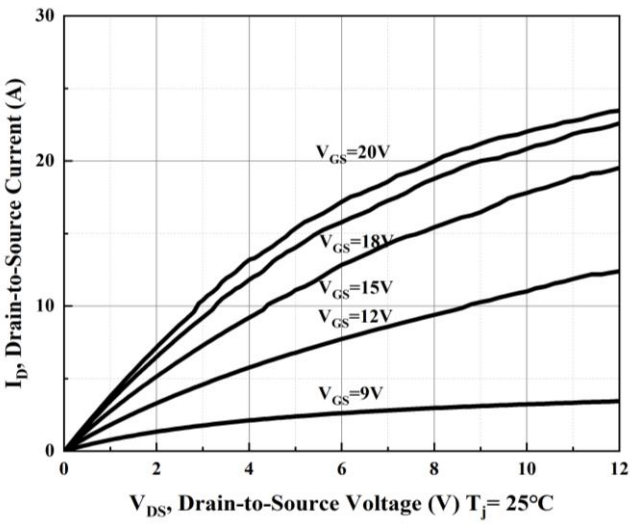


Figure2. Output Characteristics Tj = 25℃

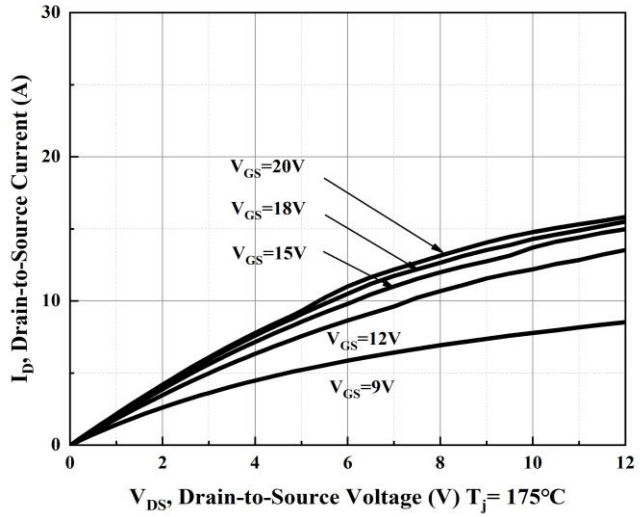


Figure 3. Output Characteristics Tj = 175℃

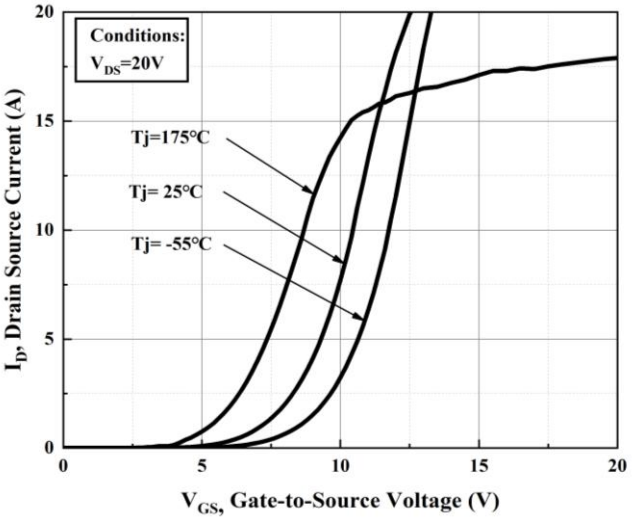


Figure 4. Transfer Characteristics for Various Junction Temperature

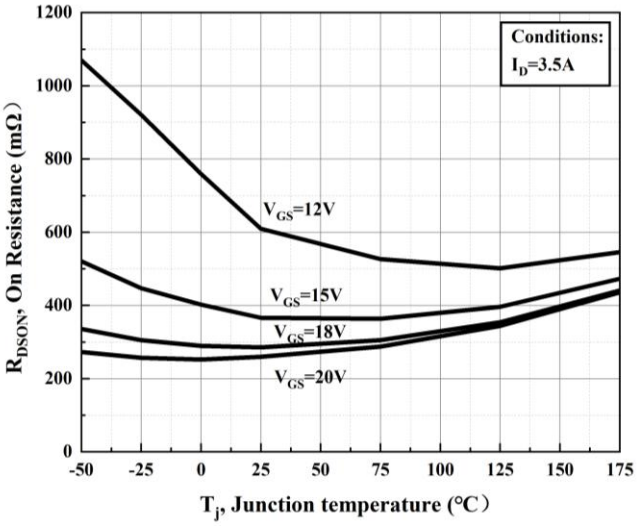


Figure 5. On-resistance vs. Temperature for Various Gate Voltage

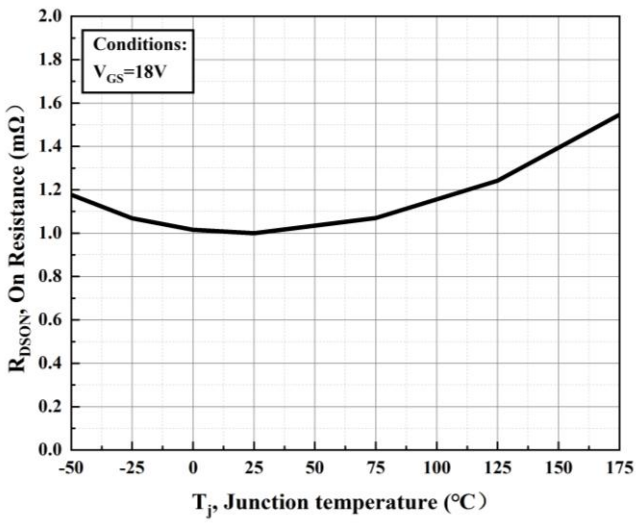


Figure 6. Normalized on-resistance vs. Temperature

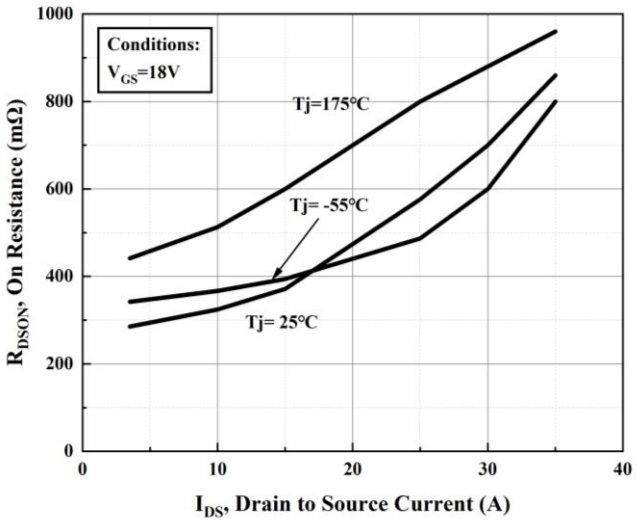


Figure 7. On-resistance vs. Drain Current

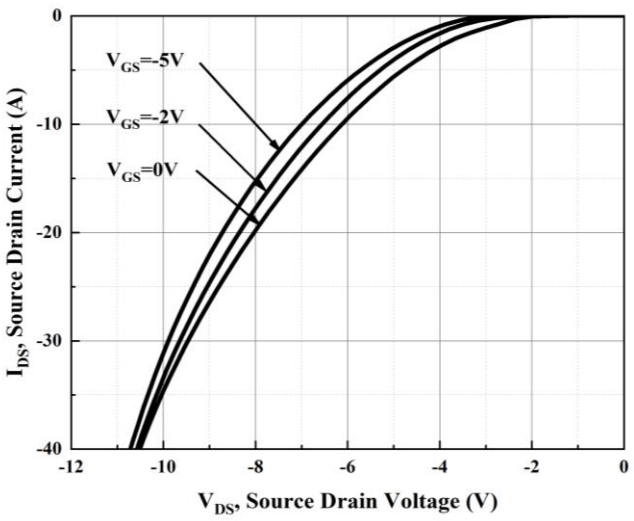


Figure 8. Body Diode Characteristic at Tj= 25 ℃

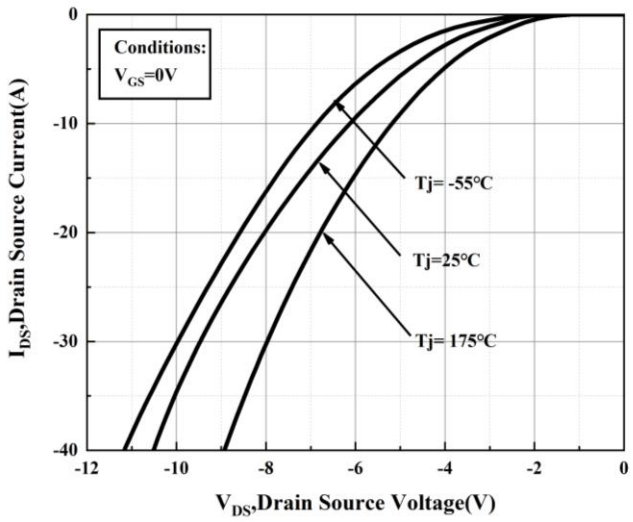


Figure 9. Body Diode Characteristic

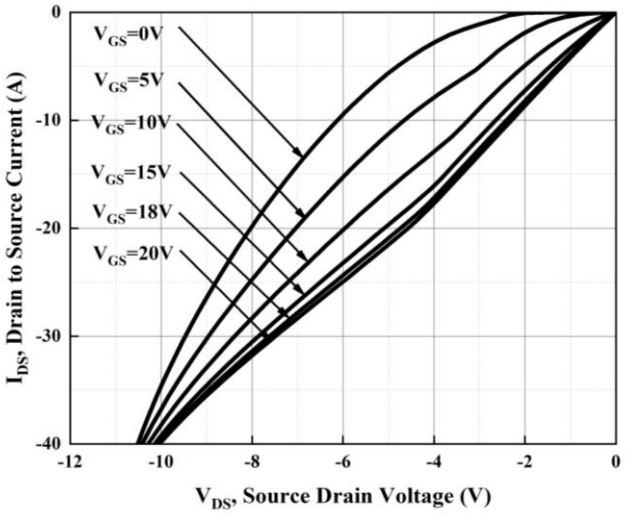


Figure 10. 3rd quadrant Characteristic at Tj= 25 ℃

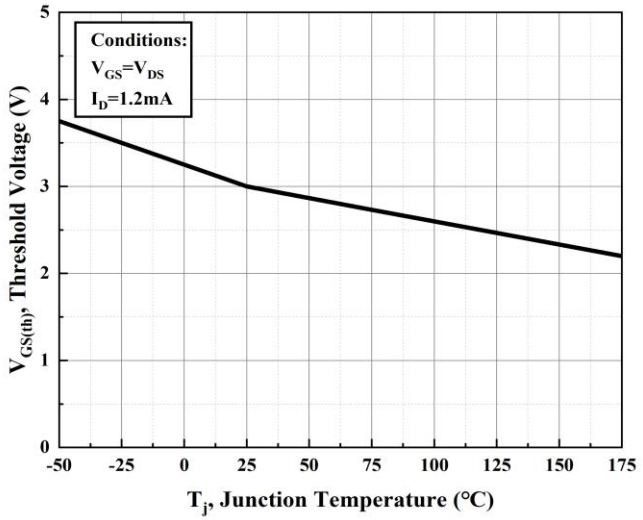


Figure 11. Threshold Voltage vs. Temperature

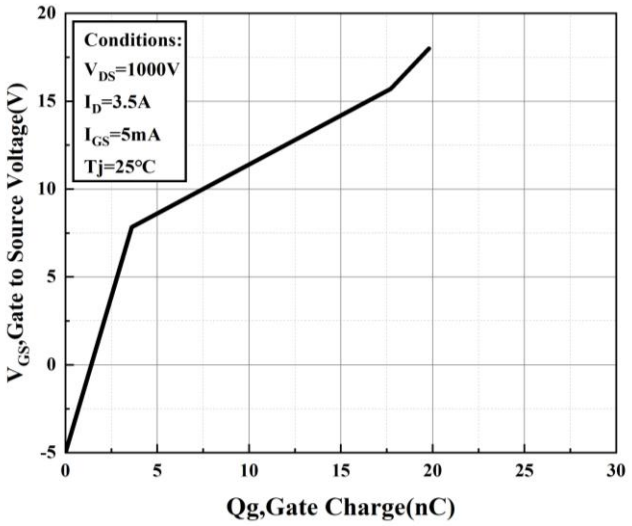


Figure 12. Gate Charge Characteristic

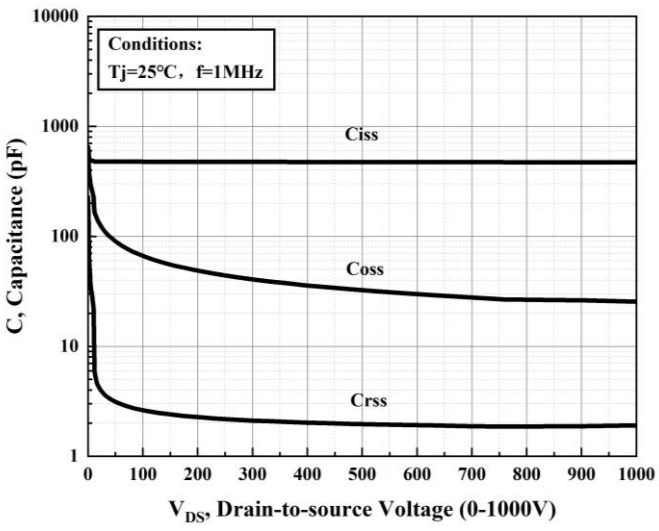


Figure 13. Capacitances vs. Drain Source Voltage (0-1000V)

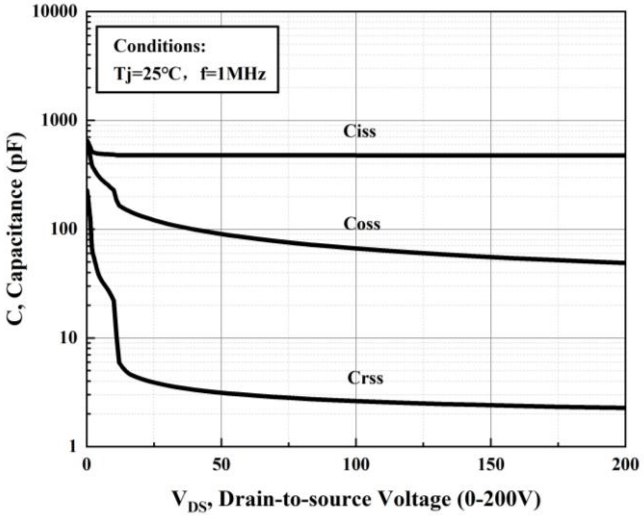


Figure 14. Capacitances vs. Drain Source Voltage (0-200V)

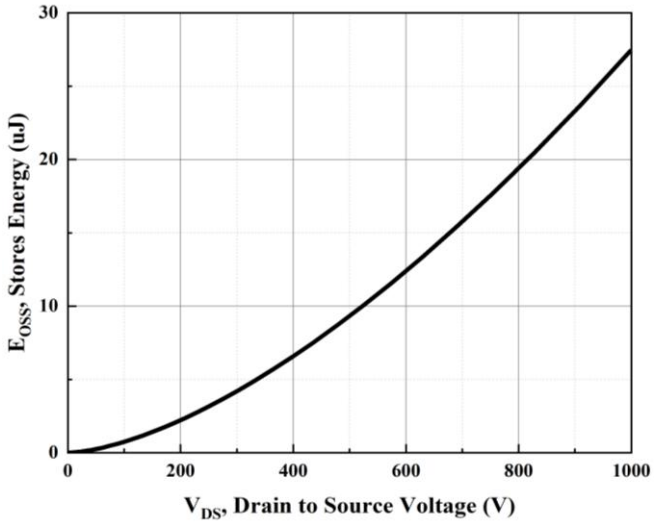


Figure 15. Output Capacitor Stored Energy

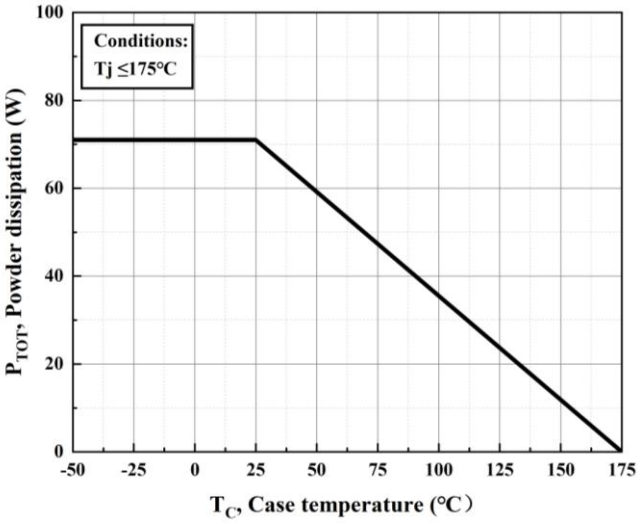


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

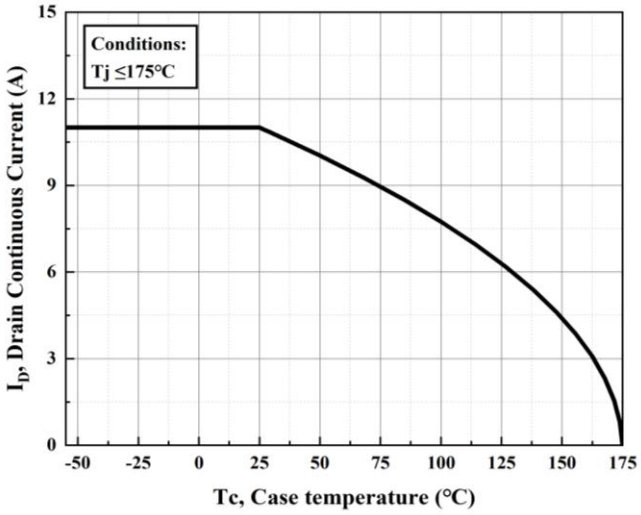


Figure 17. Coutinuous Drain Current Derating vs. Case Temperature

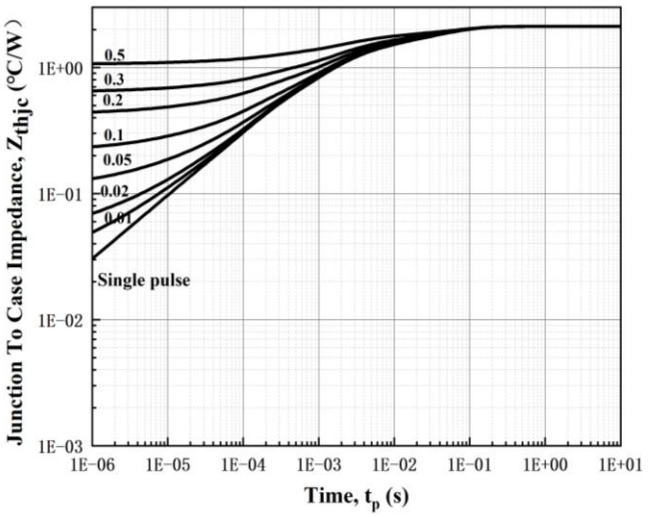


Figure18 Transient Thermal Impedance (Junction - Case)

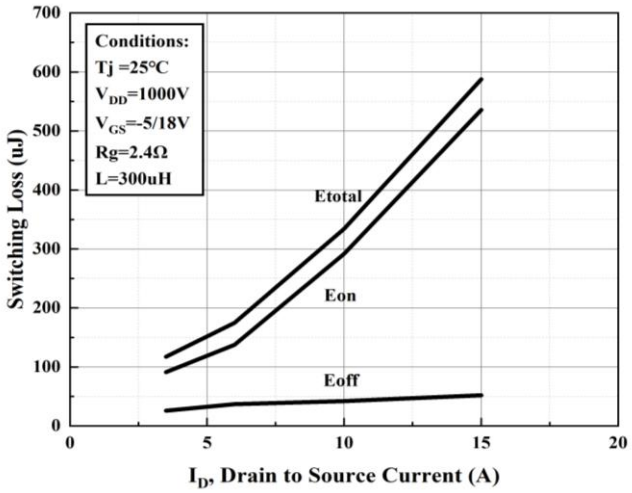


Figure 19. Clamped Inductive Switching Energy vs. Darin Current

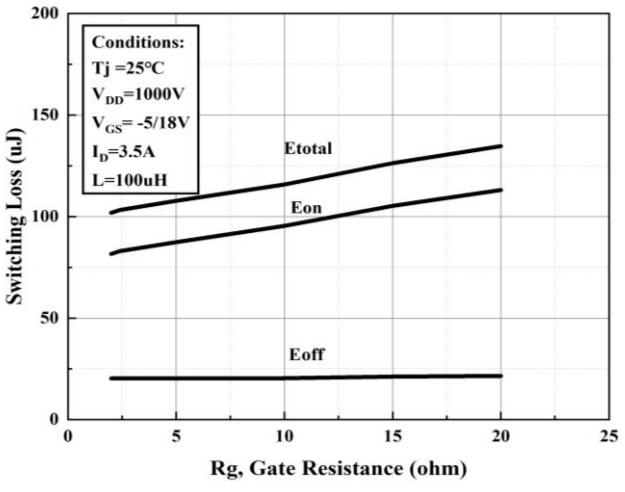


Figure 20. Clamped Inductive Switching Energy vs. Rg

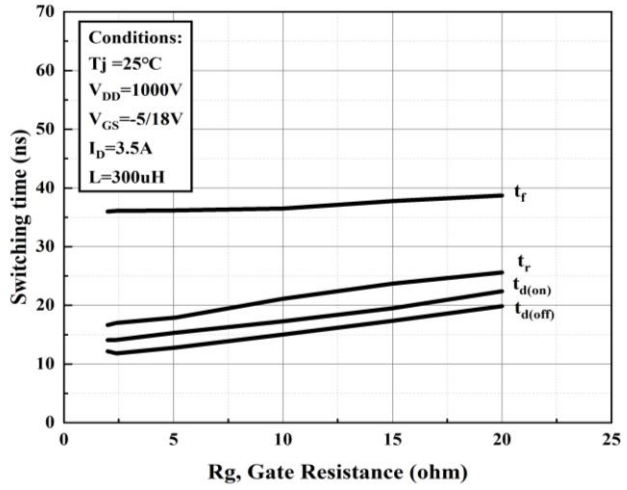


Figure 21. Switching Times vs. Rg

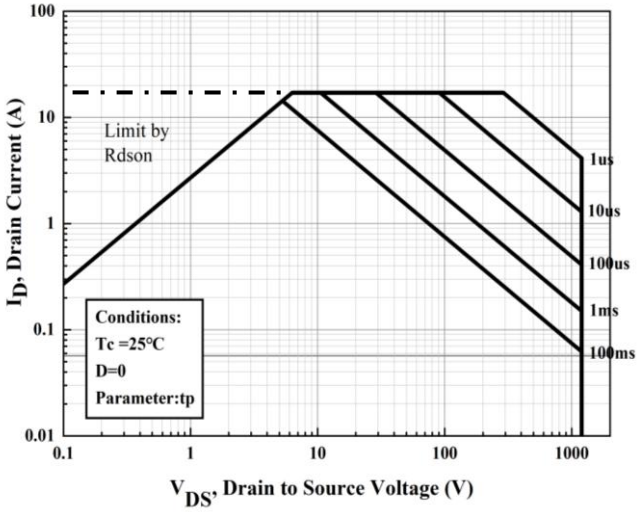


Figure 22. Safe Operating Area

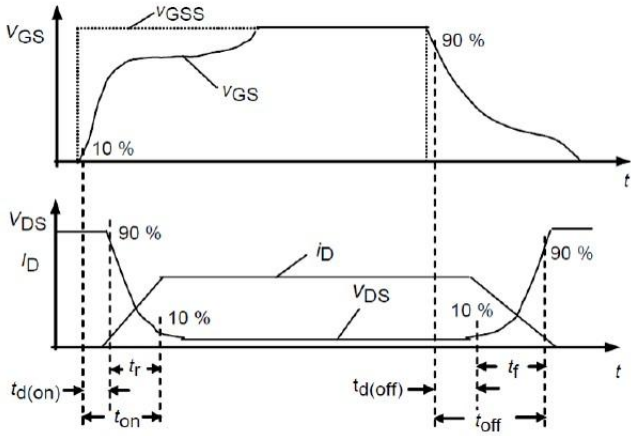


Figure 23. Switching Times Definition

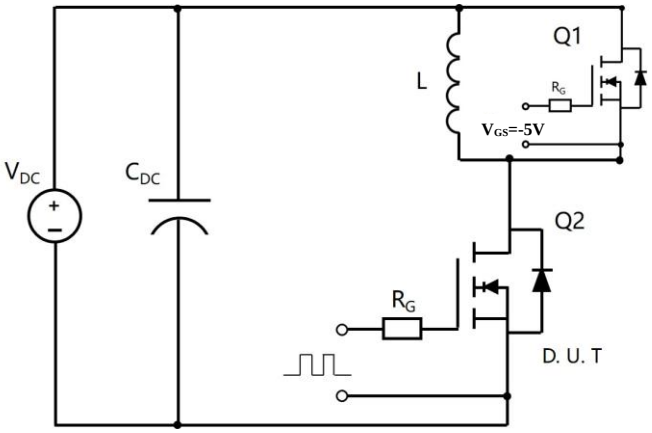
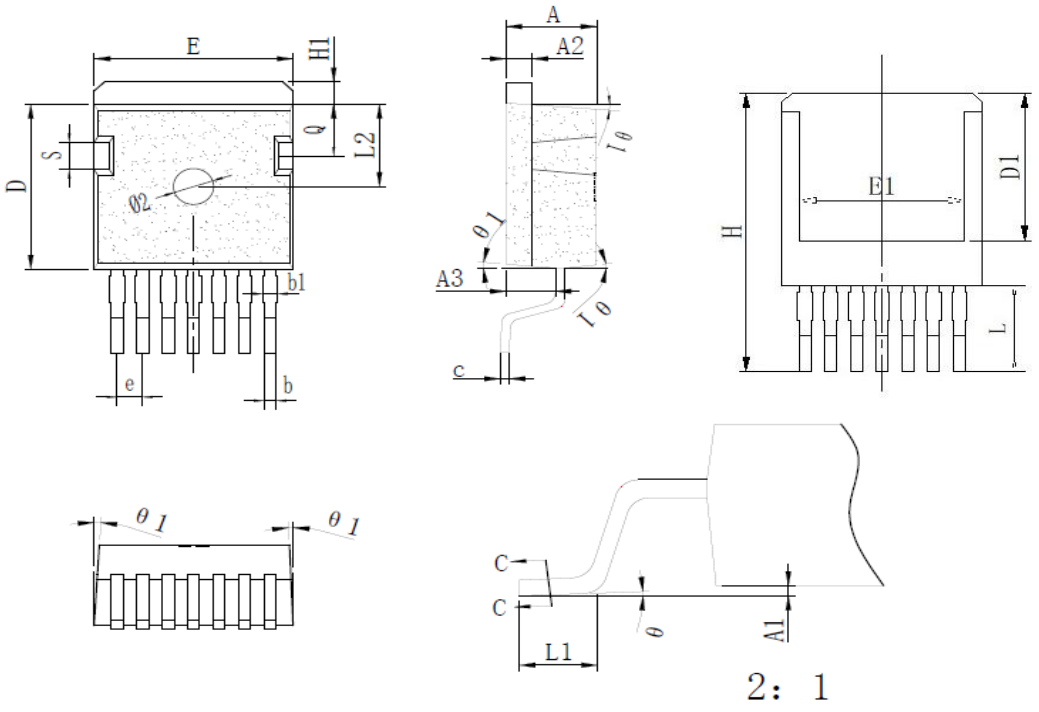
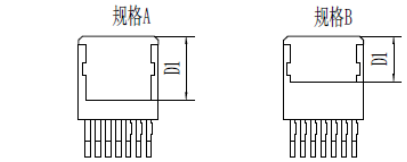


Figure 24. Clamped Inductive Switching Waveform Test Circuit

■Outline Dimensions





✻为关键管控尺寸

SYMBOL	mm		
	MIN	NOM	MAX
✻A	4.30	4.40	4.50
✻A1	0.00	0.10	0.20
✻A2	1.22	1.27	1.32
✻A3	2.30	2.40	2.50
✻b	0.50	0.60	0.70
✻b1	–	–	0.63
✻c	0.45	0.50	0.55
✻D	9.15	9.30	9.45
D1	规格A：8.00REF 规格B：5.70REF		
✻E	10.12	10.16	10.20
E1	8.20	8.40	8.60
✻e	1.25	1.27	1.29
✻H	14.85	15.00	15.15
H1	1.10	1.20	1.30
✻L	4.50	4.70	4.90
L1	1.70	2.00	2.30
L2	4.55	4.65	4.75
S	1.40	1.50	1.60
Q	2.80	2.90	3.00
✻θ	0°	2.5°	8°
θ1	5°	7°	9°

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